

ATTY DOCKET NO.  
500451-100

SERIAL NO. 10/057,223

**Eric W. McFarland**

FILING	1-25-02
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GROUP	1753
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## U.S. PATENT DOCUMENTS

[illegible]

## FOREIGN PATENT DOCUMENTS

[illegible]

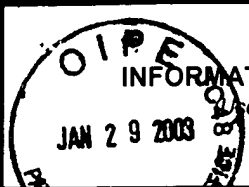
**OTHER DOCUMENTS** (Including Author, Title, Date, Pertinent Pages, Etc.)

ADD			Photoelectrochemical cells by Michael Gratzel; Nature, Vol. 414, November 15, 2001, pp. 338-344.
ADD			Solar Cell Efficiency Tables (Version 17) by Martin A. Green, Keith Emery, David L. King, Sanekazu Igari & Wilhelm Warta; Progress in Photovoltaics: Research and Applications, Prog. Photovolt: Appl. 2001; 9:49-56.

EXAMINER Alan D. ...

DATE CONSIDERED 5/12/03

**\*EXAMINER:** Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

**RECEIVED**  
 JAN 31 2003  
 TC 1700

**FOREIGN PATENT DOCUMENTS**

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO

**OTHER DOCUMENTS** (Including Author, Title, Date, Pertinent Pages, Etc.)

ADD			Quantitative Electron Spectroscopy of Surfaces: A Standard Data Base for Electron Inelastic Mean Free Paths in Solids by M.P. Seah & W.A. Dench; Surface and Interface Analysis, Vol. 1, No. 1, 1979, pp. 2-11.
ADD			Theoretical Models of Hot Carrier Effects at Metal-Semiconductor Electrodes by Karl W. Frese, Jr., & C. Chen; J. Electrochem. Soc., Vol. 139, No. 11, November, 1992, The Electrochemical Society, Inc., pp. 3234-3243.

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